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SN761662
DTV TUNER IC

SLES161–NOVEMBER 2005

FEATURES

- **Low-Phase-Noise Mixer/Oscillator and PLL Synthesizer**
- **VHF-L, VHF-H, UHF Three-Band Local Oscillator**
- **I^{2}C Bus Protocol (Bidirectional Data Transmission)**
- **30-V Tuning Voltage Output**
- **Four NPN-Type Band-Switch Drivers**
- **One Auxiliary-Port, Five-Level ADC**
- **RF AGC Detector Circuit**
- **Crystal Oscillator Output**
- **Programmable Reference Divider Ratio (24/28/50/64/80/128)**
- **Standby Mode**
- **5-V Power Supply**
- **38-Pin TSSOP Package**

APPLICATIONS

- **Digital TV**
- **Digital CATV**
- **Set-Top Box**

DESCRIPTION

The SN761662 is a low-phase-noise synthesized tuner IC designed for digital TV tuning systems. The circuit consists of a PLL synthesizer, three-band local oscillator and mixer, 30-V output tuning amplifier, four NPN band-switch drivers, and is available in a small-outline package. A 15-bit programmable counter and reference divider are controlled by I^{2}C bus protocol. Tuning step frequency is selectable by this reference divider ratio for a crystal oscillator.

DBT PACKAGE
(TOP VIEW)

|			
VLO OSC B	1	38	UHF RF IN2
VLO OSC C	2	37	UHF RF IN1
OSC GND	3	36	VHI RF IN
VHI OSC B	4	35	VLO RF IN
VHI OSC C	5	34	BS4
UHF OSC B1	6	33	RF GND
UHF OSC C1	7	32	MIXOUT2
UHF OSC C2	8	31	MIXOUT1
UHF OSC B2	9	30	NC
IF GND	10	29	BUS GND
IF OUT1	11	28	RF AGC
IF OUT2	12	27	AGC FIL2
VCC	13	26	AGC FIL1
CP	14	25	BS3
VTU	15	24	BS2
P5/ADC	16	23	BS1
XTAL1	17	22	SDA
XTAL2	18	21	SCL
XTALOUT	19	20	AS

P0034-02

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

MIXOUT1 and MIXOUT2 (pins 31 and 32) withstand 1.5 kV, and all other pins withstand 2 kV, according to the human body model (1.5 kΩ, 100 pF).
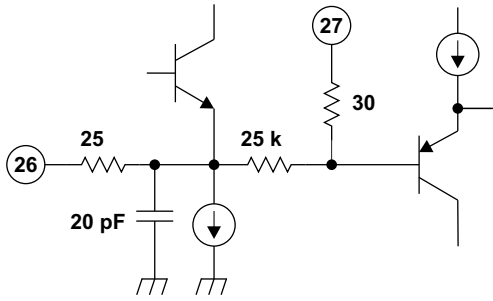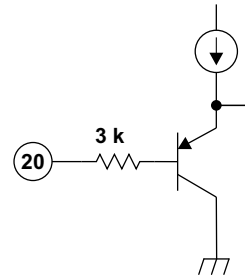
Functional Block Diagram

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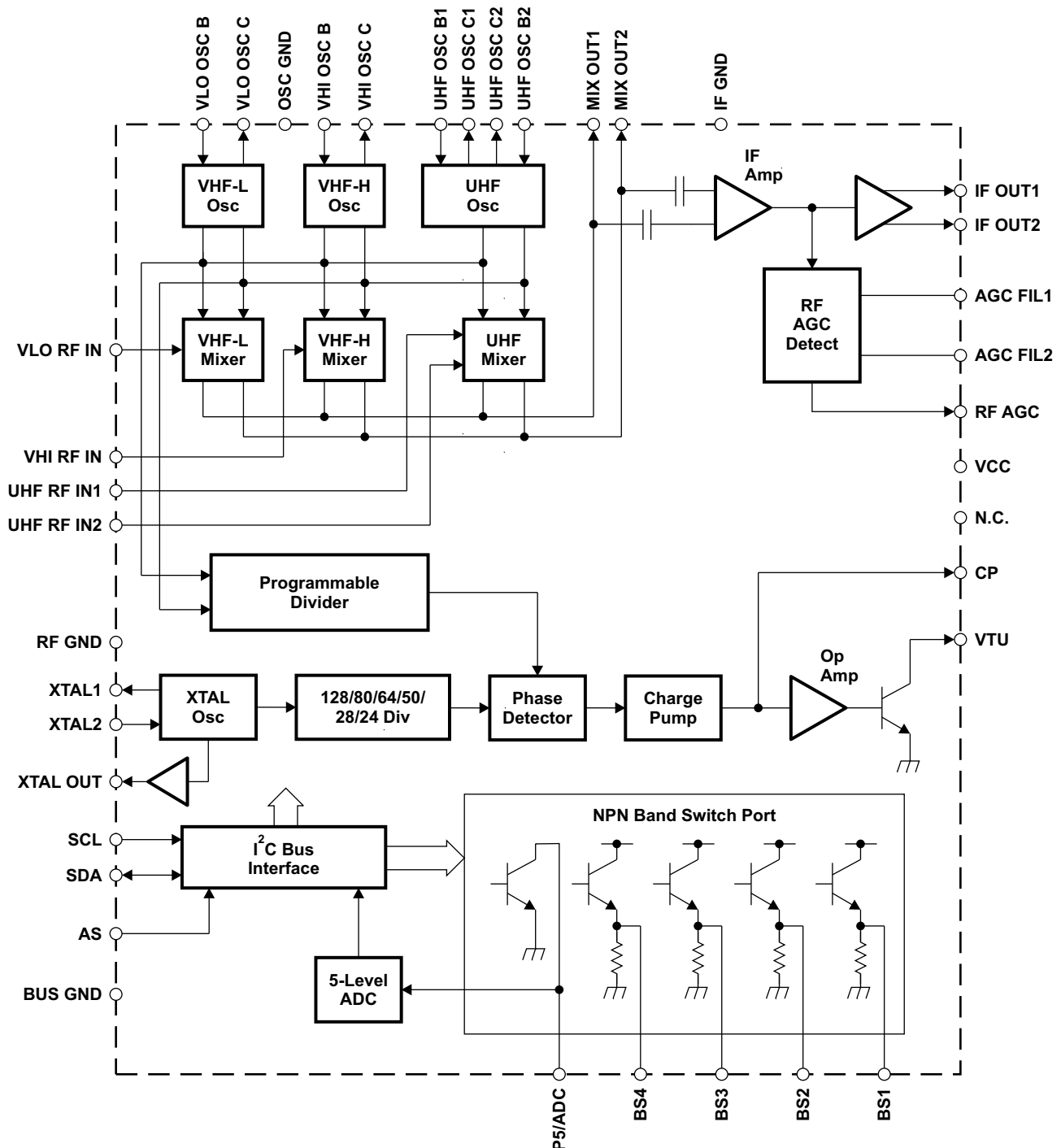
Pin Assignments

Pin Description

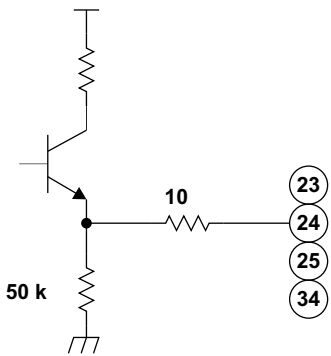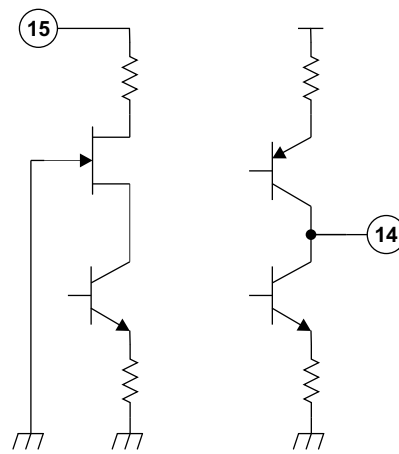| TERMINAL		DESCRIPTION	SCHEMATIC
NAME	NO.		
AGC FIL1	26	Additional peak-hold capacitor pin	Figure 1
AGC FIL2	27	RF AGC LPF capacitor pin	Figure 1
AS	20	Address selection input	Figure 2
BS1	23	Band-switch1 output	Figure 3
BS2	24	Band-switch2 output	Figure 3
BS3	25	Band-switch3 output	Figure 3
BS4	34	Band-switch4 output	Figure 3
BUS GND	29	Serial bus/band-switch ground	
CP	14	Charge pump output	Figure 4
IF GND	10	IF ground	
IF OUT1	11	IF amplifier output	Figure 5
IF OUT2	12	IF amplifier output	Figure 5
MIX OUT1	31	Mixer output	Figure 6
MIX OUT2	32	Mixer output	Figure 6
N.C.	30	No connection	
OSC GND	3	Oscillator ground	
P5/ADC	16	Port 5 output/ADC input	Figure 7
RF AGC	28	RF AGC output	Figure 8
RF GND	33	RF ground	
SCL	21	Serial clock input	Figure 9
SDA	22	Serial data input/output	Figure 10
UHF OSC B1	6	UHF oscillator base1	Figure 11
UHF OSC B2	9	UHF oscillator base2	Figure 11
UHF OSC C1	7	UHF oscillator collector1	Figure 11
UHF OSC C2	8	UHF oscillator collector2	Figure 11
UHF RFIN1	37	UHF RF input	Figure 12
UHF RFIN2	38	UHF RF input	Figure 12
VCC	13	Supply voltage for mixer/oscillator/PLL: 5 V	
VHI OSC B	4	VHF HIGH oscillator base	Figure 13
VHI OSC C	5	VHF HIGH oscillator collector	Figure 13
VHI RFIN	36	VHF-H RF input	Figure 14
VLO OSC B	1	VHF LOW oscillator base	Figure 15
VLO OSC C	2	VHF LOW oscillator collector	Figure 15
VLO RFIN	35	VHF-L RF input	Figure 18
VTU	15	Tuning voltage amplifier output	Figure 4
XTAL1	17	4-MHz crystal oscillator output	Figure 16
XTAL2	18	4-MHz crystal oscillator input	Figure 16
XTALOUT	19	4-MHz oscillator output	Figure 17
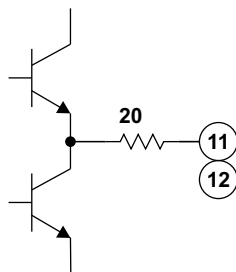
Figure 1.

Figure 2.

Figure 3.

Figure 4.

Figure 5.

Figure 6.

Figure 7.

Figure 8.

Figure 9.

Figure 10.

Figure 11.

Figure 12.

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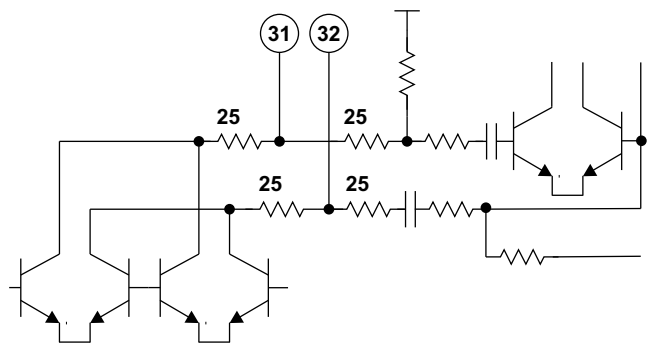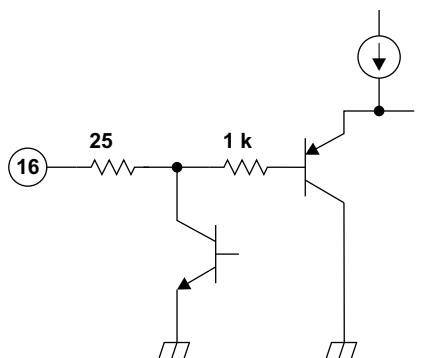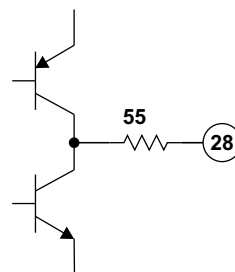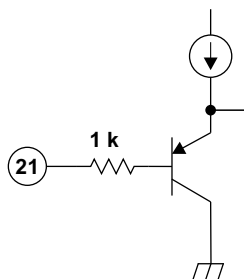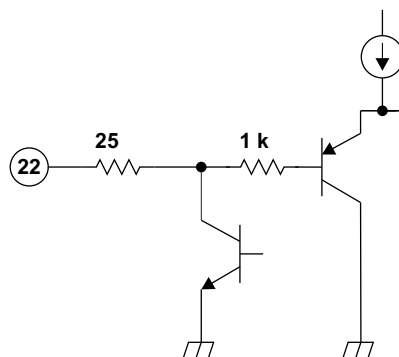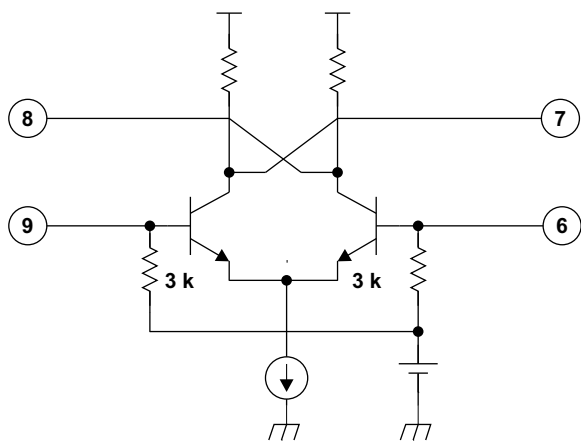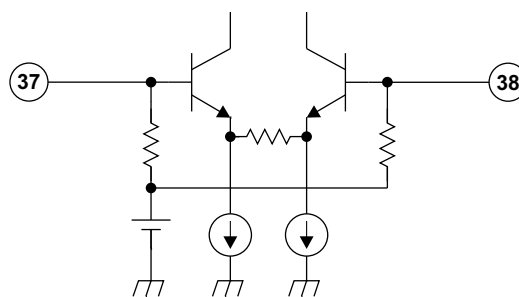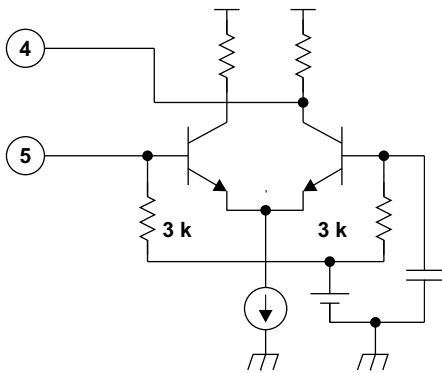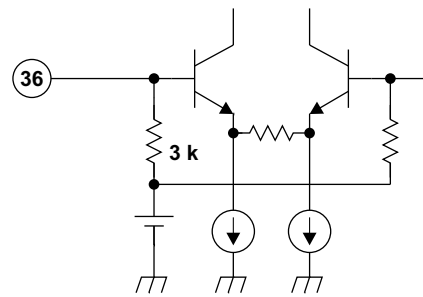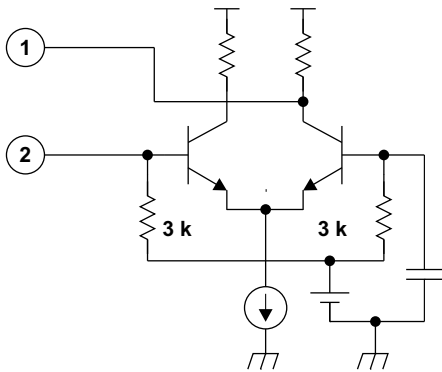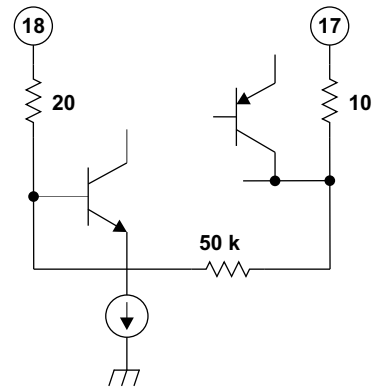
Figure 13.
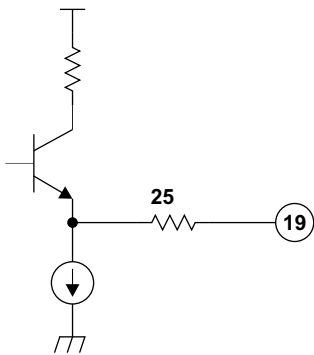
Figure 14.

Figure 15.
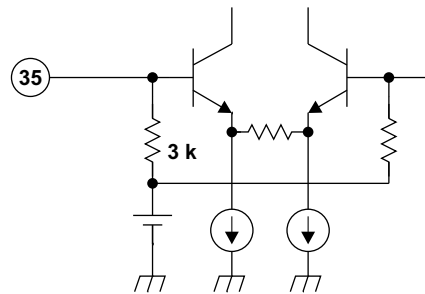
Figure 16.

Figure 17.

Figure 18.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) [1]

Supply voltage, V_{CC} [2]	VCC	−0.4 V to 6.5 V
Input voltage 1, V_{GND} [2]	RF GND, OSC GND, BUS GND	−0.4 V to 0.4 V
Input voltage 2, V_{VTU} [2]	VTU	−0.4 V to 35 V
Input voltage 3, V_{IN} [2]	Other pins	−0.4 V to 6.5 V
Continuous total dissipation, P_D [3]	$T_A \leq 25°C$	1276 mW
Operating free-air temperature, T_A		−20°C to 85°C
Storage temperature range, T_{stg}		−65°C to 150°C
Maximum junction temperature, T_J		150°C
Maximum short-circuit time, $t_{SC(max)}$	Each pin to V_{CC} or to GND	10 s

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) Voltage values are with respect to the IF GND of the circuit.
(3) Derating factor is 10.2 mW/°C for $T_A \geq 25°C$.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}		4.5	5	5.5	V
Tuning supply voltage, V_{TU}			30	33	V
Output current of band switch, I_{BS}	One band switch on			10	mA
Output current of port 5, I_{P5}				−5	mA
Operating free-air temperature, T_A		−20		85	°C

ELECTRICAL CHARACTERISTICS, Total Device and Serial Interface

V_{CC} = 4.5 V to 5.5 V, T_A = −20°C to 85°C, unless otherwise noted

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_{CC}1$	Supply current 1			75		mA
$I_{CC}2$	Supply current 2	One band switch on (I_{BS} = 10 mA)		87		mA
$I_{CC\text{-}STBY}$	Standby supply current	STBY = 1			8	mA
V_{IH}	High-level input voltage (SCL, SDA)		2.3			V
V_{IL}	Low-level input voltage (SCL, SDA)				1.35	V
I_{IH}	High-level input current (SCL, SDA)				10	µA
I_{IL}	Low-level input current (SCL, SDA)		−10			µA
V_{POR}	Power-on-reset supply voltage (threshold of supply voltage between reset and operation mode)		2.1	2.8	3.5	V
I²C INTERFACE						
V_{ASH}	Address-select high-input voltage (AS)	V_{CC} = 5 V	4.5		5	V
V_{ASM1}	Address-select mid-input1 voltage (AS)	V_{CC} = 5 V	2		3	V
V_{ASM2}	Address-select mid-input2 voltage (AS)	V_{CC} = 5 V	1		1.5	V
V_{ASL}	Address-select low-input voltage (AS)	V_{CC} = 5 V			0.5	V
I_{ASH}	Address-select high-input current (AS)				10	µA
I_{ASL}	Address-select low-input current (AS)		−10			µA
V_{ADC}	ADC input voltage	See Table 10	0		V_{CC}	V
I_{ADH}	ADC high-level input current	V_{ADC} = V_{CC}			10	µA
I_{ADL}	ADC low-level input current	V_{ADC} = 0 V	−10			µA
V_{OL}	Low-level output voltage (SDA)	V_{CC} = 5 V, I_{OL} = 3 mA			0.4	V
I_{SDAH}	High-level output leakage current (SDA)	V_{SDA} = 5.5 V			10	µA
f_{SCL}	Clock frequency (SCL)			100	400	kHz
$t_{HD\text{-}DAT}$	Data hold time	See timing chart, Figure 19	0			µs
t_{BUF}	Bus free time		1.3			µs
$t_{HD\text{-}STA}$	Start hold time		0.6			µs
t_{LOW}	SCL-low hold time		0.6			µs
t_{HIGH}	SCL-high hold time		0.6			µs
$t_{SU\text{-}STA}$	Start setup time		0.6			µs
$t_{SU\text{-}DAT}$	Data setup time		0.1			µs
t_r	SCL, SDA rise time				0.3	µs
t_f	SCL, SDA fall time				0.3	µs
$t_{SU\text{-}STO}$	Stop setup time		0.6			µs

ELECTRICAL CHARACTERISTICS, PLL and Band Switch

V_{CC} = 4.5 V to 5.5 V, T_A = −20°C to 85°C, unless otherwise noted

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
N	Divider ratio	15-bit frequency word	512		32767	
f_{XTAL}	Crystal oscillator frequency	R_{XTAL} = 25 Ω to 300 Ω		4		MHz
Z_{XTAL}	Crystal oscillator input impedance			1.6		kΩ
V_{XLO}	XTALOUT output voltage	Load = 10 pF/5.1 kΩ, V_{CC} = 5 V, T_A = 25°C		0.37		Vp-p
V_{VTUL}	Tuning amplifier low-level output voltage	R_L = 20 kΩ, V_{TU} = 33 V	0.2	0.3	0.46	V
I_{VTUOFF}	Tuning amplifier leakage current	Tuning amplifier = off, V_{TU} = 33 V			10	μA
I_{CP11}	Charge-pump current	CP[1:0] = 11		600		μA
I_{CP10}		CP[1:0] = 10		300		
I_{CP01}		CP[1:0] = 01		140		
I_{CP00}		CP[1:0] = 00		70		
V_{CP}	Charge-pump output voltage	PLL locked		1.95		V
I_{CPOFF}	Charge-pump leakage current	V_{CP} = 2 V, T_A = 25°C	−15		15	nA
I_{BS}	Band-switch driver output current (BS1–BS4)				10	mA
V_{BS1}	Band-switch driver output voltage (BS1–BS4)	I_{BS} = 10 mA	3			V
V_{BS2}		I_{BS} = 10 mA, V_{CC} = 5 V, T_A = 25°C	3.5	3.9		
I_{BSOFF}	Band-switch driver leakage current (BS1–BS4)	V_{BS} = 0 V			8	μA
I_{P5}	Band-switch port sink current (P5/ADC)				−5	mA
V_{P5ON}	Band-switch port output voltage (P5/ADC)	I_{P5} = −2 mA, V_{CC} = 5 V, T_A = 25°C			0.6	V

ELECTRICAL CHARACRTERISTICS, RF AGC

V_{CC} = 5 V, T_A = 25°C, measured in Figure 20 reference measurement circuit at 50-Ω system, IF = 44 MHz, IF filter characteristics: f_{peak} = 44 MHz, unless otherwise noted

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{OAGC0}	RF AGC output current	ATC = 0		900		nA
I_{OAGC1}		ATC = 1		9		μA
$V_{AGCSP00}$	Start-point IF output level	T1/ATSS = 0, ATP[2:0] = 000		117		dBμV
$V_{AGCSP01}$		T1/ATSS = 0, ATP[2:0] = 001		114		
$V_{AGCSP02}$		T1/ATSS = 0, ATP[2:0] = 010		111		
$V_{AGCSP03}$		T1/ATSS = 0, ATP[2:0] = 011		108		
$V_{AGCSP04}$		T1/ATSS = 0, ATP[2:0] = 100		105		
$V_{AGCSP05}$		T1/ATSS = 0, ATP[2:0] = 101		102		
$V_{AGCSP06}$		T1/ATSS = 0, ATP[2:0] = 110		99		
$V_{AGCSP10}$		T1/ATSS = 1, ATP[2:0] = 000		112		
$V_{AGCSP11}$		T1/ATSS = 1, ATP[2:0] = 001		109		
$V_{AGCSP12}$		T1/ATSS = 1, ATP[2:0] = 010		106		
$V_{AGCSP13}$		T1/ATSS = 1, ATP[2:0] = 011		103		
$V_{AGCSP14}$		T1/ATSS = 1, ATP[2:0] = 100		100		
$V_{AGCSP15}$		T1/ATSS = 1, ATP[2:0] = 101		97		
$V_{AGCSP16}$		T1/ATSS = 1, ATP[2:0] = 110		94		

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ELECTRICAL CHARACTERISTICS, Mixer, Oscillator, IF Amplifier

V_{CC} = 5 V, T_A = 25°C, measured in Figure 20 reference measurement circuit at 50-Ω system, IF = 44 MHz, IF filter characteristics: f_{peak} = 44 MHz (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
G_{c1}	Conversion gain (mixer-IF amplifier), VHF-LOW	f_{in} = 57 MHz [1]		35		dB
G_{c3}		f_{in} = 171 MHz [1]		35		
G_{c4}	Conversion gain (mixer-IF amplifier), VHF-HIGH	f_{in} = 177 MHz [1]		35		dB
G_{c6}		f_{in} = 467 MHz [1]		35		
G_{c7}	Conversion gain (mixer-IF amplifier), VHF-UHF	f_{in} = 473 MHz [1]		35		dB
G_{c9}		f_{in} = 864 MHz [1]		35		
NF_1	Noise figure, VHF-LOW	f_{in} = 57 MHz		9		dB
NF_3		f_{in} = 171 MHz		9		
NF_4	Noise figure, VHF-HIGH	f_{in} = 177 MHz		9		dB
NF_6		f_{in} = 467 MHz		9		
NF_7	Noise figure, UHF	f_{in} = 473 MHz		12		dB
NF_9		f_{in} = 864 MHz		12		
CM_1	1% cross-modulation distortion, VHF-LOW	f_{in} = 57 MHz [2]		79		dBμV
CM_3		f_{in} = 171 MHz [2]		79		
CM_4	1% cross-modulation distortion, VHF-HIGH	f_{in} = 177 MHz [2]		79		dBμV
CM_6		f_{in} = 467 MHz [2]		79		
CM_7	1% cross-modulation distortion, UHF	f_{in} = 473 MHz [2]		77		dBμV
CM_9		f_{in} = 864 MHz [2]		77		
V_{IFO1}	IF output voltage, VHF-LOW	f_{in} = 57 MHz		117		dBμV
V_{IFO3}		f_{in} = 171 MHz		117		
V_{IFO4}	IF output voltage, VHF-HIGH	f_{in} = 177 MHz		117		dBμV
V_{IFO6}		f_{in} = 467 MHz		117		
V_{IFO7}	IF output voltage, UHF	f_{in} = 473 MHz		117		dBμV
V_{IFO9}		f_{in} = 864 MHz		117		
Φ_{PLVL11}	Phase noise, VHF-LOW	f_{in} = 57 MHz, offset = 1 kHz [3]		−90		dBc/Hz
Φ_{PLVL12}		f_{in} = 57 MHz, offset = 10 kHz [4]		−95		
Φ_{PLVL31}		f_{in} = 171 MHz, offset = 1 kHz [5]		−85		
Φ_{PLVL32}		f_{in} = 171 MHz, offset = 10 kHz [4]		−95		
Φ_{PLVL41}	Phase noise, VHF-HIGH	f_{in} = 177 MHz, offset = 1 kHz [3]		−85		dBc/Hz
Φ_{PLVL42}		f_{in} = 177 MHz, offset = 10 kHz [4]		−90		
Φ_{PLVL61}		f_{in} = 467 MHz, offset = 1 kHz [5]		−77		
Φ_{PLVL62}		f_{in} = 467 MHz, offset = 10 kHz [4]		−90		
Φ_{PLVL71}	Phase noise, UHF	f_{in} = 473 MHz, offset = 1 kHz [3]		−80		dBc/Hz
Φ_{PLVL72}		f_{in} = 473 MHz, offset = 10 kHz [4]		−85		
Φ_{PLVL91}		f_{in} = 864 MHz, offset = 1 kHz [5]		−77		
Φ_{PLVL92}		f_{in} = 864 MHz, offset = 10 kHz [4]		−90		

(1)   RF input level = 70 dBμV, differential output
(2) f_{undes} = f_{des} ±6 MHz, P_{in} = 80 dBμV, AM 1 kHz, 30%, DES/CM = S/I = 46 dB
(3)   CP[1:0] = 10 (CP current 350 μA), RS[2:0] = 011 (reference divider 64)
(4)   CP[1:0] = 00 (CP current 70 μA), RS[2:0] = 100 (reference divider 128)
(5)   CP[1:0] = 11 (CP current 600 μA), RS[2:0] = 100 (reference divider 128)

Functional Description

I²C Bus Mode

I²C Write Mode (R/$\overline{W}$ = 0)

Table 1. Write Data Format

	MSB							LSB	
[(1)]Address byte (ADB)	1	1	0	0	0	MA1	MA0	R/$\overline{W}$ = 0	A
Divider byte 1 (DB1)	0	N14	N13	N12	N11	N10	N9	N8	A
Divider byte 2 (DB2)	N7	N6	N5	N4	N3	N2	N1	N0	A
Control byte 1 (CB1)	1	0	ATP2	ATP1	ATP0	RS2	RS1	RS0	A
Band-switch byte (BB)	CP1	CP0	0	P5	BS4	BS3	BS2	BS1	A
Control byte 2 (CB2)	1	1	ATC	STBY	T3	T2	T1/ATSS	T0/XLO	A

(1)   A: Acknowledge

Table 2. Description of Data Symbols

SYMBOL	DESCRIPTION	DEFAULT
MA[1:0]	Address-set bits (see Table 3, *Address Selection*)	
N[14:0]	Programmable counter set bits $N = N14 \times 2^{14} + N13 \times 2^{13} + ... + N1 \times 2 + N0$	N14 = N13 = N12 = ... = N0 = 0
CP[1:0]	Charge-pump current-set bit 60 µA (CP = 0); 280 µA (CP = 1)	CP = 1
T[2:0}	RF AGC start-point control bits (see Table 4, *RF AGC Start Point*)	ATP[2:0] = 011
RSA, RSB	Reference divider ratio-selection bits (see Table 5, *Reference Divider Ratio*)	RSA = 0, RSB = 1
OS	Tuning amplifier control bit Tuning voltage on (OS = 0) Tuning voltage off, high impedance (OS = 1)	OS = 0
BS[4:1]	Band-switch control bits BSn = 0: OFF BSn = 1: ON Band selection by BS[1:2] **BS1 BS2** 1 0 VHF-LO 0 1 VHF-HI 0 0 UHF 1 1 Reserved	BSn = 0
X	Don't care	

Table 3. Address Selection

MA1	MA0	Voltage Applied on AS Input
0	0	0 V to 0.1 V_{CC}
0	1	OPEN, or 0.2 V_{CC} to 0.3 V_{CC}
1	0	0.4 V_{CC} to 0.6 V_{CC}
1	1	0.9 V_{CC} to V_{CC}

Table 4. RF AGC Start Point

T1/ATSS	ATP2	ATP1	ATP0	IFOUT Level, dBμV
0	0	0	0	117
0	0	0	1	114
0	0	1	0	111
0	0	1	1	108
0	1	0	0	105
0	1	0	1	102
0	1	1	0	99
0	1	1	1	Disabled
1	0	0	0	112
1	0	0	1	109
1	0	1	0	106
1	0	1	1	103
1	1	0	0	100
1	1	0	1	97
1	1	1	0	94
1	1	1	1	Disabled

Table 5. Reference Divider Ratio

RS2	RS1	RS0	Reference Divider Ratio
0	0	0	24
0	0	1	28
0	1	0	50
0	1	1	64
1	0	0	128
1	X	1	80

Table 6. Charge Pump Current

CP1	CP0	Charge Pump Current, μA
0	0	70
0	1	140
1	0	350
1	1	600

Table 7. Test Bits/XTALOUT Control [1]

T3	T2	T1/ATSS	T0/XLO	Device Operation	XTALOUT 4-MHz Output
0	0	X	0	Normal operation	Enabled
0	0	X	1	Normal operation	Disabled
X	1	X	X	Test mode	Not available
1	X	X	X	Test mode	Not available

(1) RFAGC and XTALOUT are not available in test mode.

Example I^{2}C Data Write Sequences

Telegram examples:

Start-ADB-DB1-DB2-CB1-BB-CB2-Stop
Start-ADB-DB1-DB2-Stop
Start-ADB-CB1-BB-CB2-Stop
Start-ADB-CB1-BB-Stop
Start-ADB-CB2-Stop

Abbreviations:

ADB: Address byte
BB: Band-switch byte
CB1: Control byte 1
CB2: Control byte 2
DB1: Divider byte 1
DB2: Divider byte 2
Start: Start condition
Stop: Stop condition

I^{2}C Read Mode (R/$\overline{W}$ = 1)

Table 8. Read Data Format (A: Acknowledge)

	MSB							LSB	
Address byte (ADB)	1	1	0	0	0	MA1	MA0	R/$\overline{W}$ = 1	A
Status byte (SB)	POR	FL	1	1	X	A2	A1	A0	–

Table 9. Description of Data Symbols

SYMBOL	DESCRIPTION	DEFAULT
MA[1:0]	Address set bits (see Table 3, *Address Selection*)	
POR	Power-on-reset flag POR set: power on POR reset: end-of-data transmission procedure	POR = 1
FL	In-lock flag PLL locked (FL = 1), unlocked (FL = 0)	
A[2:0]	Digital data of ADC (see Table 10, *ADC Level*) Bit P5 must be set to 0.	

Table 10. ADC Level[1]

A2	A1	A0	Voltage Applied on ADC Input
1	0	0	0.6 V_{CC} to V_{CC}
0	1	1	0.45 V_{CC} to 0.6 V_{CC}
0	1	0	0.3 V_{CC} to 0.45 V_{CC}
0	0	1	0.15 V_{CC} to 0.3 V_{CC}
0	0	0	0 V to 0.15 V_{CC}

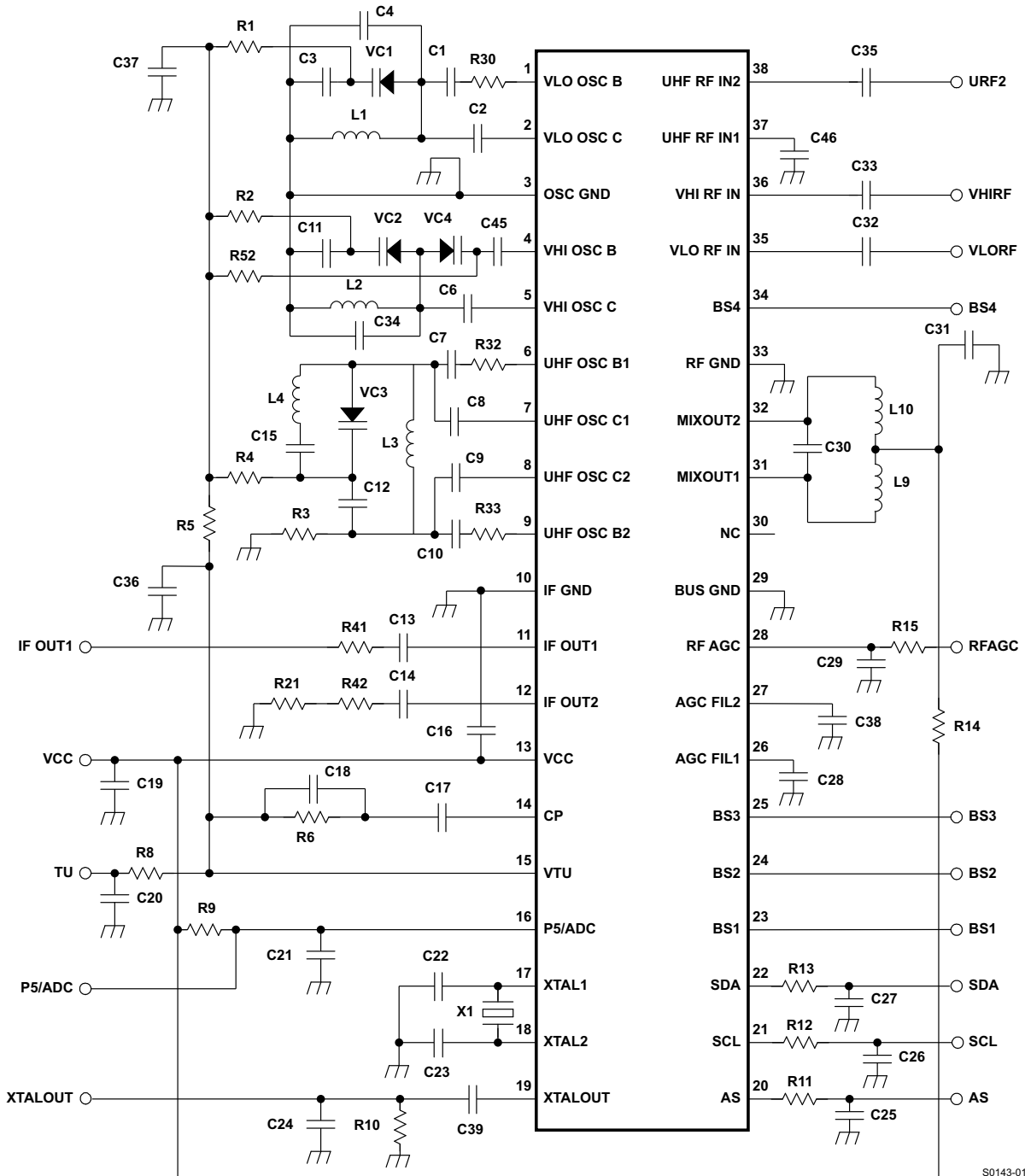(1)   Accuracy is $0.03 \times V_{CC}$.
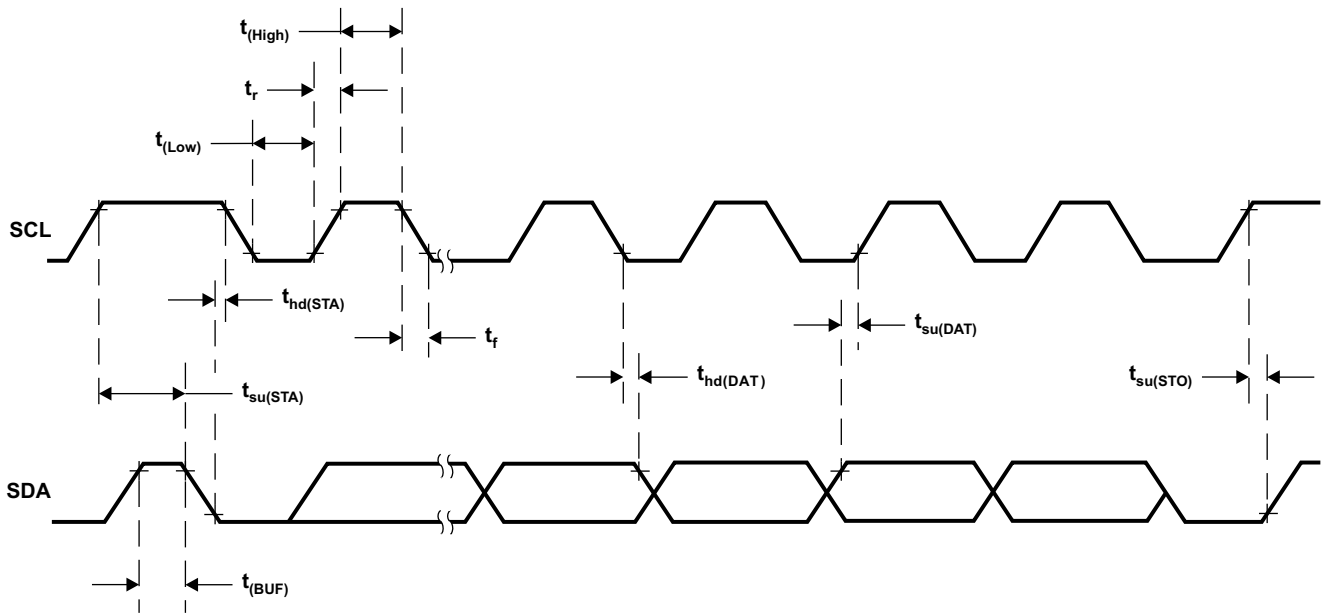
T0101-01

Figure 19. I²C Timing Chart

APPLICATION INFORMATION
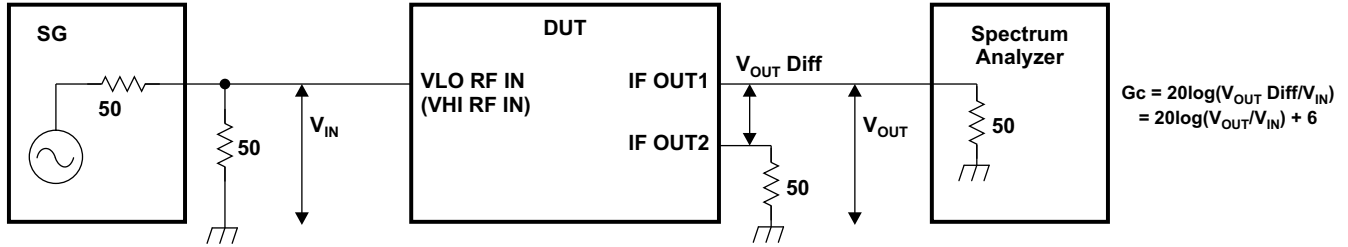
Reference Measurement Circuit

NOTE: This application information is advisory and a performance-check is required for actual application circuits. TI assumes no responsibility for the consequences of the use of this circuit nor for any infringement of patent or patent rights of third parties which may result from its use.

Figure 20. Reference Measurement Circuit

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APPLICATION INFORMATION (continued)

Component Values for Measurement Circuit

PART NAME	VALUE	PART NAME	VALUE
C1 (VLO OSCB)	1 pF	C39 (XTALOUT)	2.2 nF
C2 (VLO OSCC)	2 pF	C45 (VHI OSC)	7 pF
C3 (VLO OSC)	47 pF	C46 (URF1)	2.2 nF
C4 (VLO OSC)	Open	L1 (VLO OSC)	ϕ 3,0 mm, 7T, wire 0,32 mm
C6 (VHI OSCC)	5 pF	L2 (VHI OSC)	ϕ2,0 mm, 3T, wire 0,4 mm
C7 (UHF OSCB1)	1 pF	L3 (UHF OSC)	ϕ1,8 mm, 3T, wire 0,4 mm
C8 (UHF OSCC1)	1 pF	L4 (UHF OSC)	ϕ1,8 mm, 3T, wire 0,4 mm
C9 (UHF OSCC2)	1 pF	L9 (MIXOUT)	680 nH (LK1608R68K-T)
C10 (UHF OSCB2)	1 pF	L10 (MIXOUT)	680 nH (LK1608R68K-T)
C11 (VHI OSC)	51 pF	R1 (VLO OSC)	3.3 kΩ
C12 (UHF OSC)	10 pF	R2 (VHI OSC)	3.3 kΩ
C13 (IFOUT)	2.2 nF	R3 (UHF OSC)	2.2 kΩ
C14 (IFOUT)	2.2 nF	R4 (UHF OSC)	1 kΩ
C15 (UHF OSC)	100 pF	R5 (VTU)	3 kΩ
C16 (VCC)	4.7 nF	R6 (CP)	47 kΩ
C17 (CP)	0.01 μF/50 V	R8 (VTU)	20 kΩ
C18 (CP)	22 pF/50 V	R9 (P5/ADC)	Open
C19 (VCC)	2.2 nF	R10 (XTALOUT)	5.1 kΩ
C20 (VTU)	2.2 nF/50 V	R11 (AS)	330 Ω
C21 (P5/ADC)	Open	R12 (SCL)	330 Ω
C22 (XTAL)	27 pF	R13 (SDA)	330 Ω
C23 (XTAL)	27 pF	R14 (VCC)	0
C24 (XTALOUT)	10 pF	R15 (RFAGC)	0
C25 (AS)	Open	R21 (IFOUT)	1 kΩ
C26 (SCL)	Open	R30 (VLO OSC)	10
C27 (SDA)	Open	R32 (UHF OSC)	0
C28 (AGCFIL1)	0.1 μF	R33 (UHF OSC)	0
C29 (RFAGC)	0.15 μF	R41 (IFOUT)	1 kΩ
C30 (MIXOUT)	5 pF	R42 (IFOUT)	0
C31 (MIXOUT)	2.2 nF	R52 (VHI OSC)	3.3 kΩ
C32 (VLORF)	2.2 nF	U1	SN761662
C33 (VHIRF)	2.2 nF	VC1 (VLO OSC)	MA2S374
C34 (VHI OSC)	0.5 pF	VC2 (VHI OSC)	MA2S374
C35 (URF2)	2.2 nF	VC3 (UHF OSC)	MA2S372
C36 (VTU)	Open	VC4 (VHI OSC)	MA2S372
C37 (VTU)	2.2 nF/50 V	X1	4-MHz crystal
C38 (RGCFIL2)	Open		

Test Circuits

S0144-01

Figure 21. VHF-Conversion Gain-Measurement Circuit

$Gc = 20log(V_{OUT} \text{ Diff}/V_{IN})$
$= 20log(V_{OUT}/V_{IN}) + 6$
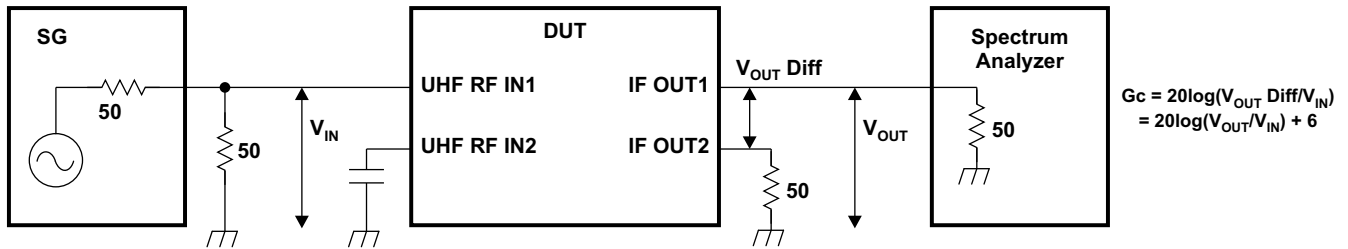
S0145-01

Figure 22. UHF-Conversion Gain-Measurement Circuit

$Gc = 20log(V_{OUT} \text{ Diff}/V_{IN})$
$= 20log(V_{OUT}/V_{IN}) + 6$
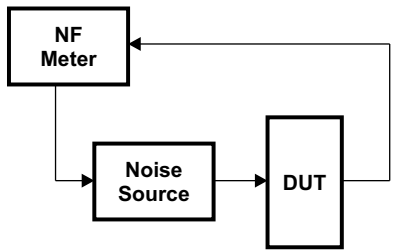
B0090-01

Figure 23. Noise-Figure Measurement Circuit
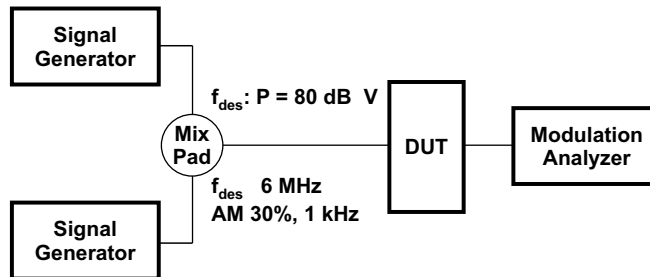
B0091-01

Figure 24. 1% Cross-Modulation Distortion Measurement Circuit

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TYPICAL CHARACTERISTICS

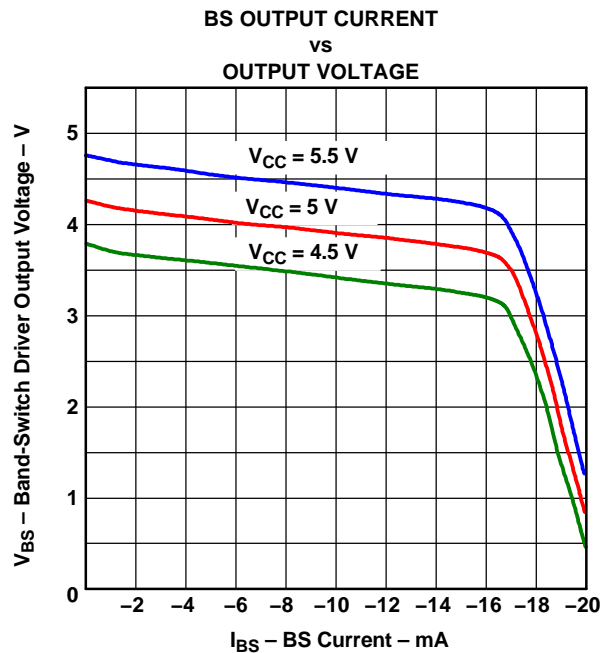## Band-Switch Driver Output Voltage (BS1–BS4)

Figure 25. Band-Switch Driver Output Voltage
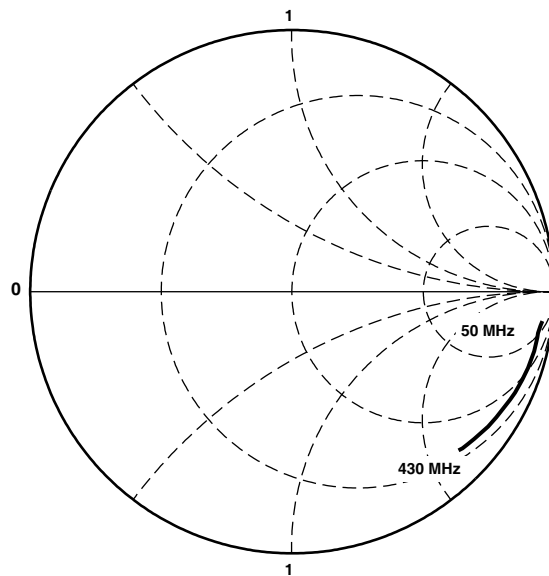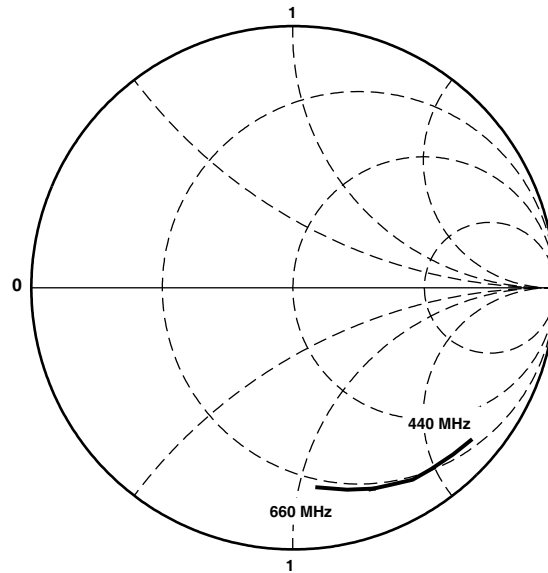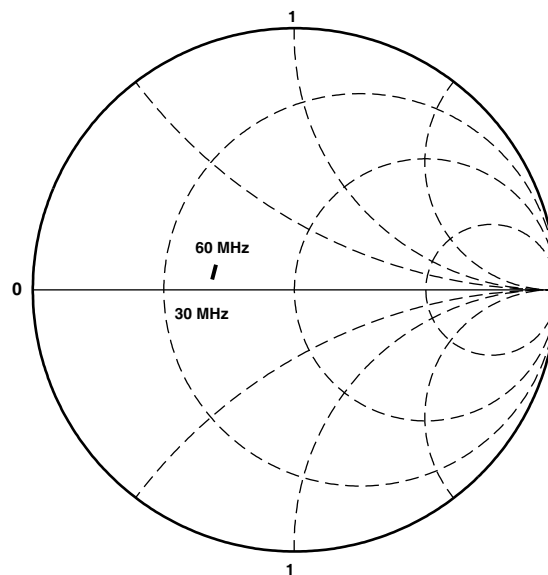
S-Parameter

Figure 26. VLO RFIN, VHI RFIN

TYPICAL CHARACTERISTICS (continued)

M0047-02

Figure 27. UHF RFIN

M0047-03

Figure 28. IFOUT

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